IPC ASSOCIATION CON ELECTRONICS INC	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both le	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Mater					ials and Mfc Information			
upplier In	nformation													
Company name*			Company un	Company unique ID			Unique ID Authority				Response Date*			
nsemi										2024-05-12				
Contact Name	e	Title - Contact			P	Phone - Contact*				Email - Contact*				
Product-Env-	-Stewards		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com			
uthorized Re	epresentative*	Title - Representative			P	Phone - Representative*			Email - Representative*					
Product-Env-	-Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
Re	equester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	N	Manufacturing Site		eight*	UOM	Unit Type
		HCPL0500R2V		SO8 1MB TR T&R VDE			2024-05-12		Т	тнн		68.58636	mg	Each
Ianufactu	ring Proccess Inform	ation							·					
Terminal Plating / Grid Array Material Terminal Base Alloy J-S7			STD-020 MSL F	Rating Peak Process Body Temperature Max Time at Peak					Temperatu	re Numbe	r of Reflow Cyc	eles		
Matte Tin (Sn) - annealed CU Alloy			1			260		С	30	second	s 3			
omments														
vel 1 - maxir	mum time at peak tempera	ture during sol	dering is 10-3	30 seconds										
or more info	ormation regarding materia	al composition	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correction this form using appropriate methods to ensure its accuracy and that such information is true and correction to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has not or written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supp											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	el Substance		Exempt	Weight	Unit of Measure	
Coupling Gel	4.18236	mg	Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.046	mg	
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		4.1364	mg	
Die	4.043	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.283	mg	
			Supplier	Silicon (Si)	7440-21-3		3.76	mg	
Die Attach	0.754	mg	Supplier	Silver (Ag)	7440-22-4		0.6032	mg	
			Supplier	Phenolic Resin-2	54208-63-8		0.1508	mg	
Lead Frame	59.197	mg	Supplier	Silver (Ag)	7440-22-4		0.148	mg	
			Supplier	Zinc (Zn)	7440-66-6		0.071	mg	
			Supplier	Iron (Fe)	7439-89-6		1.36	mg	
			Supplier	Copper (Cu)	7440-50-8		57.6	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.018	mg	
Mold Compound-White	98.06	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4-hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		3.92	mg	
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		23.5	mg	
			В	Antimony Trioxide (Sb2O3)	1309-64-4		2.94	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		67.7	mg	
Plating	2.1	mg	Supplier	Tin (Sn)	7440-31-5		2.1	mg	
Wire Bond - Au	0.25	mg	Supplier	Gold (Au)	7440-57-5		0.25	mg	